

P-Channel 60 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------|--|---------------------------------|----------------------|--|--|
| V _{DS} (V) | R_{DS(on)} (Ω) | I _D (A) ^d | Q _g (Typ) | | |
| - 60 | 0.070 at V _{GS} = - 10 V | - 25 | 30 | | |
| - 00 | 0.082 at V_{GS} = - 4.5 V | - 30 | 50 | | |

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

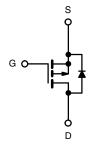
APPLICATIONS

- High Side Switch for Full Bridge Converter
- DC/DC Converter for LCD Display



TO-252

Top View



P-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise note) | | | | | | |
|--|------------------------|-----------------------------------|---------------------|-----|--|--|
| Parameter | Symbol | Limit | Unit | | | |
| Drain-Source Voltage | V _{DS} | - 60 | V | | | |
| Gate-Source Voltage | V _{GS} ± 20 | | V | | | |
| Continuous Drain Current ($T_{,1} = 150 \ ^{\circ}C$) | T _C = 25 °C | I_ | - 25 | | | |
| Continuous Drain Current (1) = 150°C) | T _C = 100°C | - I _D - | - 20 | | | |
| Pulsed Drain Current | | I _{DM} | - 75 | A | | |
| Avalanche Current, Single Pulse | L = 0.1 mH | I _{AS} | - 22 |] | | |
| Repetitive Avalanche Energy, Single Pulse ^a | L = 0.1 mm | E _{AS} | 24.2 | mJ | | |
| Power Dissinction | T _C = 25 °C | PD | 38.5 ^c | - w | | |
| Power Dissipation | T _A = 25 °C | - 'D | 2.3 ^{b, c} | | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Martine to Anthing b | t ≤ 10 s | R _{thJA} | 17 | 21 | °C/W | |
| Maximum Junction-to-Ambient ^b | Steady State | | 45 | 55 | | |
| Maximum Junction-to-Case | | R _{thJC} | 2.7 | 3.25 | | |
| Notes: | | | | | | |

a. Duty cycle \leq 1 %.

b. When mounted on 1" square PCB (FR-4 material).

c. See SOA curve for voltage derating.

HALOGEN

Available

d. Based up on $T_C = 25 \ ^{\circ}C$.



| Parameter | Symbol | Test Conditions | Min . | Тур. | Max. | Unit |
|---|------------------------------|--|-------|-------|-------|------|
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V_{GS} = 0 V, I _D = - 250 µA | - 60 | | | V |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$ | - 1 | | - 3 | V |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0$ V, $V_{GS} = \pm 20$ V | | | ± 100 | nA |
| | | $V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$ | | | - 1 | μΑ |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$ | | | - 50 | |
| | | V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 150 $^{\circ}$ C | | | - 125 | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} = -5 V$, $V_{GS} = -10 V$ | - 20 | | | Α |
| | | V _{GS} = - 10 V, I _D = - 10 A | 0.070 | | | Ω |
| Drain-Source On-State Resistance ^a | Brach | V_{GS} = - 10 V, I _D = - 10 A, T _J = 125 °C | | | | |
| Drain-Source On-State Resistance* | R _{DS(on)} | V_{GS} = - 10 V, I _D = - 10 A, T _J = 150 °C | | 0.115 | Ω | |
| | | $V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -5 \text{ A}$ | | 0.082 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = - 10 A | | 22 | | S |
| Dynamic ^b | | | | | | |
| Input Capacitance | C _{iss} | | | 1000 | | pF |
| Output Capacitance | C _{oss} | $V_{GS} = 0 V$, $V_{DS} = -25 V$, f = 1 MHz | | 130 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 90 | | |
| Total Gate Charge ^c | Qg | | | 30 | 45 | nC |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -10$ A | | 4.5 | | |
| Gate-Drain Charge ^c | Q _{gd} | 1 | | 7 | | |
| Gate Resistance | Rg | f = 1 MHz | | 7 | | Ω |
| Turn-On Delay Time ^c | t _{d(on)} | | | 8 | 15 | |
| Rise Time ^c | t _r | V_{DD} = - 30 V, R _L = 3 Ω | | 9 | 15 | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong$ - 19 A, V_{GEN} = - 10 V, R_g = 2.5 Ω | | 80 | | ns |
| Fall Time ^c | t _f | | | 30 | 45 | |
| Drain-Source Body Diode and Characte | eristics (T _C = 2 | 5 °C) ^b | | | | |
| Continuous Current | I _S | | | | - 25 | |
| Pulsed Current | I _{SM} | | | | - 75 | A |
| Forward Voltage ^a | V _{SD} | I _F = - 19 A, V _{GS} = 0 V | | - 1 | - 1.5 | V |
| Reverse Recovery Time | t _{rr} | I _F = - 19 A, di/dt = 100 A/μs | | 41 | 61 | ns |

Notes:

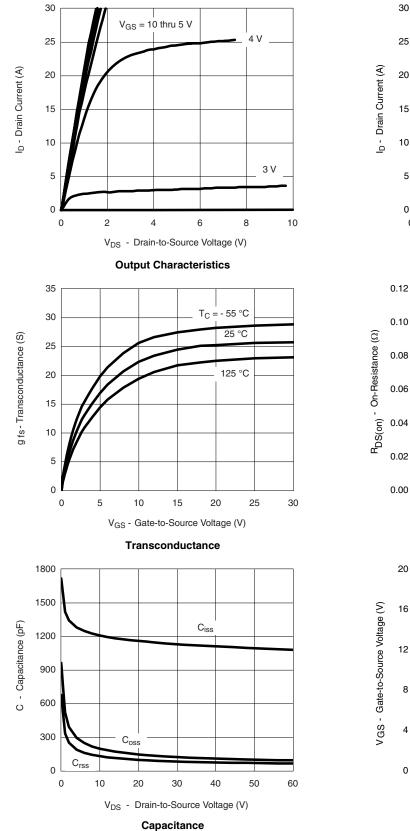
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

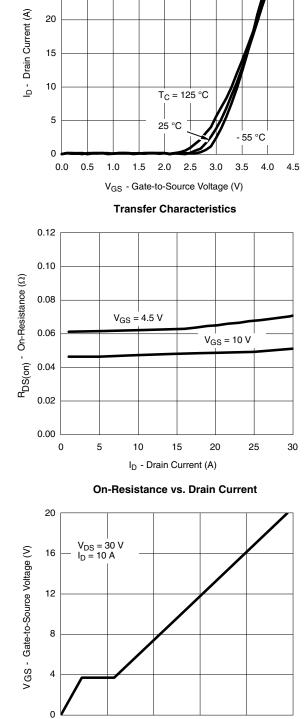
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





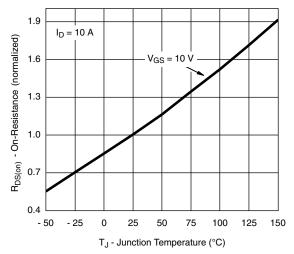
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Q_g - Total Gate Charge (nC) Gate Charge



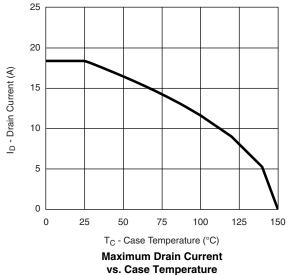


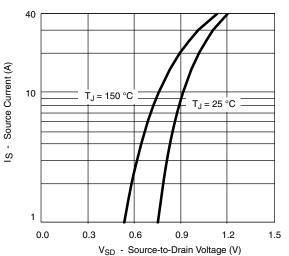


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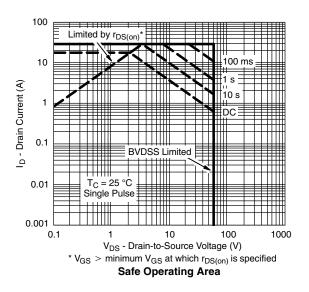


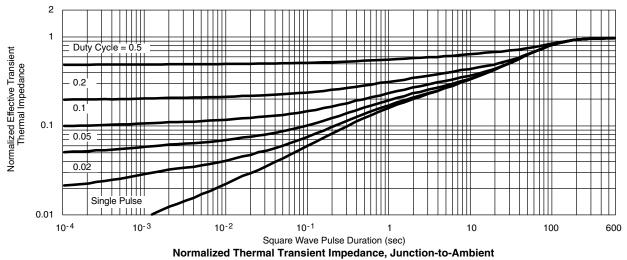






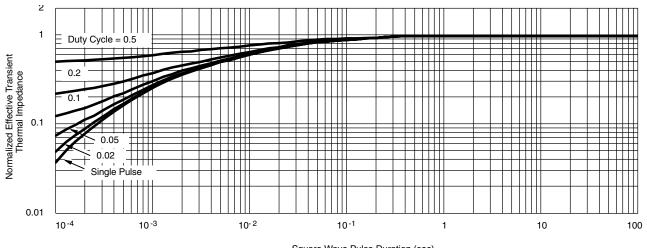
Source-Drain Diode Forward Voltage







THERMAL RATINGS

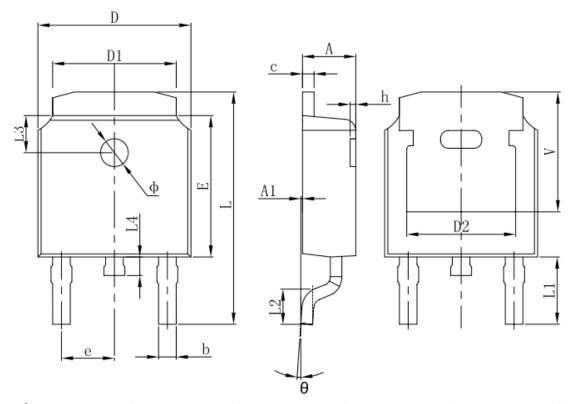


Square Wave Pulse Duration (sec)

Normalized Thermal Transient Impedance, Junction-to-Case



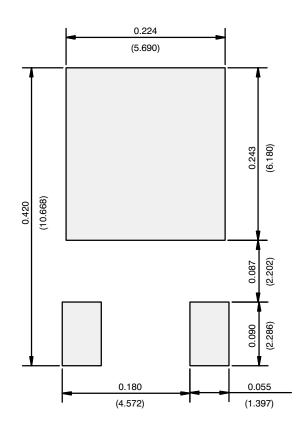
TO252 Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
|--------|---------------------------|------------|----------------------|-------|--|
| | Min. | Max. | Min. | Max. | |
| Α | 2.200 | 2.400 | 0.087 | 0.094 | |
| A1 | 0.000 | 0.127 | 0.000 | 0.005 | |
| b | 0.635 | 0.770 | 0.025 | 0.030 | |
| С | 0.460 | 0.580 | 0.018 | 0.023 | |
| D | 6.500 | 6.700 | 0.256 | 0.264 | |
| D1 | 5.100 | 5.460 | 0.201 | 0.215 | |
| D2 | 4.830 | 4.830 REF. | | REF. | |
| E | 6.000 | 6.200 | 0.236 | 0.244 | |
| е | 2.186 | 2.386 | 0.086 | 0.094 | |
| L | 9.712 | 10.312 | 0.382 | 0.406 | |
| L1 | 2.900 | REF. | 0.114 REF. | | |
| L2 | 1.400 | 1.700 | 0.055 | 0.067 | |
| L3 | 1.600 | REF. | 0.063 REF. | | |
| L4 | 0.600 | 1.000 | 0.024 | 0.039 | |
| Φ | 1.100 | 1.300 | 0.043 | 0.051 | |
| θ | 0° | 8° | 0° | 8° | |
| h | 0.000 | 0.300 | 0.000 | 0.012 | |
| V | 5.250 | REF. | 0.207 REF. | | |



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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